

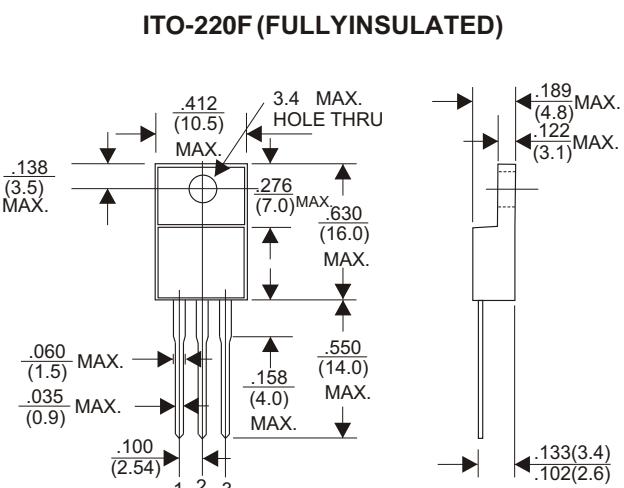
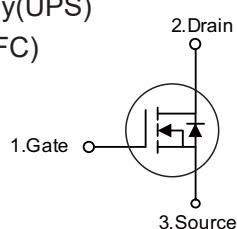
N-Channel Enhancement Mode MOSFET

Features

- 650V, 10A
- $R_{DS(ON)} = 0.87\Omega$ (Typ.) @ $V_{GS} = 10V$, $I_D = 5A$
- Fast Switching
- Improved dv/dt Capability
- 100% Avalanche Tested

Application

- Switch Mode Power Supply(SMPS)
- Uninterruptible Power Supply(UPS)
- Power Factor Correction (PFC)



Dimensions in inches and (millimeters)

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ C$ unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	650	V
Gate-Source Voltage	V_{GSS}	± 30	V
Avalanche Current (Note 2)	I_{AR}	10	A
Drain Current	Continuous I_D	10	A
	Pulsed (Note 2) I_{DM}	38	A
Avalanche Energy	Single Pulsed (Note 3) E_{AS}	700	mJ
	Repetitive (Note 2) E_{AR}	15.6	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	4.5	V/ns
Power Dissipation	P_D	50	W
Junction Temperature	T_J	+150	°C
Operating Temperature	T_{OPR}	-55 ~ +150	°C
Storage Temperature	T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

3. $L = 14.2\text{mH}$, $I_{AS} = 10\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25 \Omega$ Starting $T_J = 25^\circ C$

4. $I_{SD} \leq 9.5\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ C$

10N65F

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise specified)

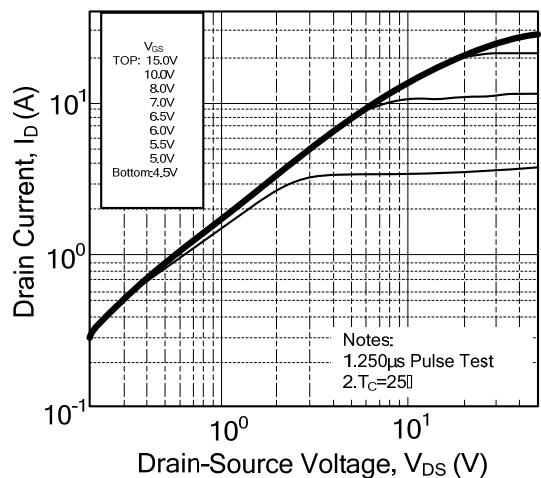
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	650			V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}} = 650\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
Gate-Source Leakage Current	Forward	I_{GSS}	$V_{\text{GS}} = 30\text{ V}, V_{\text{DS}} = 0\text{ V}$		100	nA
	Reverse		$V_{\text{GS}} = -30\text{ V}, V_{\text{DS}} = 0\text{ V}$		-100	nA
Breakdown Voltage Temperature Coefficient	$\Delta\text{BV}_{\text{DSS}}/\Delta T_J$	$I_{\text{D}} = 250\mu\text{A}$, Referenced to 25°C		0.7		$\text{V}/^\circ\text{C}$
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 5.0\text{A}$		0.87	1.2	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{ MHz}$		1570	2040	pF
Output Capacitance	C_{OSS}			166	215	pF
Reverse Transfer Capacitance	C_{RSS}			18	24	pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$t_{\text{D(ON)}}$	$V_{\text{DD}}=325\text{V}, I_{\text{D}}=10\text{A}, R_{\text{G}}=25\Omega$ (Note 1, 2)		23	55	ns
Turn-On Rise Time	t_{R}			69	150	ns
Turn-Off Delay Time	$t_{\text{D(OFF)}}$			144	300	ns
Turn-Off Fall Time	t_{F}			77	165	ns
Total Gate Charge	Q_{G}	$V_{\text{DS}}=520\text{V}, I_{\text{D}}=10\text{A}, V_{\text{GS}}=10\text{ V}$ (Note 1, 2)		44	57	nC
Gate-Source Charge	Q_{GS}			6.7		nC
Gate-Drain Charge	Q_{GD}			18.5		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Drain-Source Diode Forward Voltage	V_{SD}	$V_{\text{GS}} = 0\text{ V}, I_{\text{S}} = 10\text{A}$			1.4	V
Maximum Continuous Drain-Source Diode Forward Current	I_{S}				10	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				38	A
Reverse Recovery Time	t_{rr}	$V_{\text{GS}} = 0\text{ V}, I_{\text{S}} = 10\text{A},$ $dI_{\text{F}}/dt = 100\text{ A}/\mu\text{s}$ (Note 1)		420		ns
Reverse Recovery Charge	Q_{RR}			4.2		μC

Notes: 1. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$

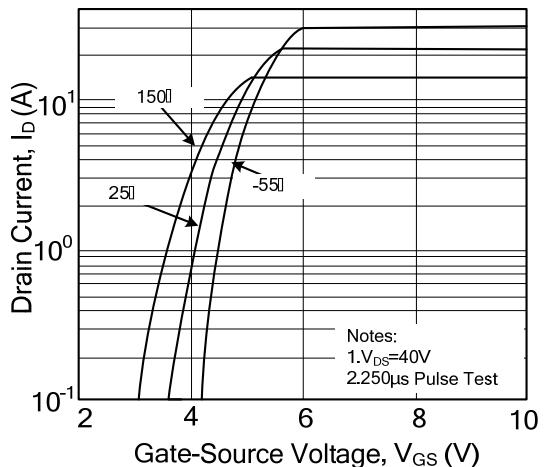
2. Essentially independent of operating temperature

RATING AND CHARACTERISTIC CURVES (10N65F)

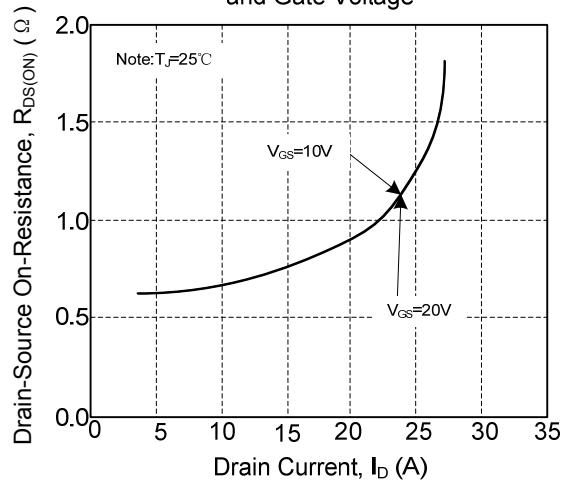
On-Region Characteristics



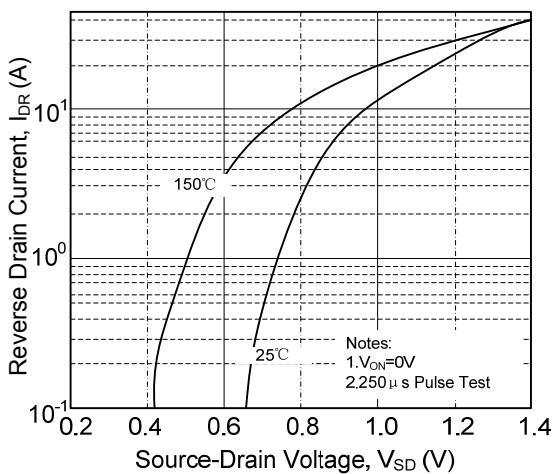
Transfer Characteristics



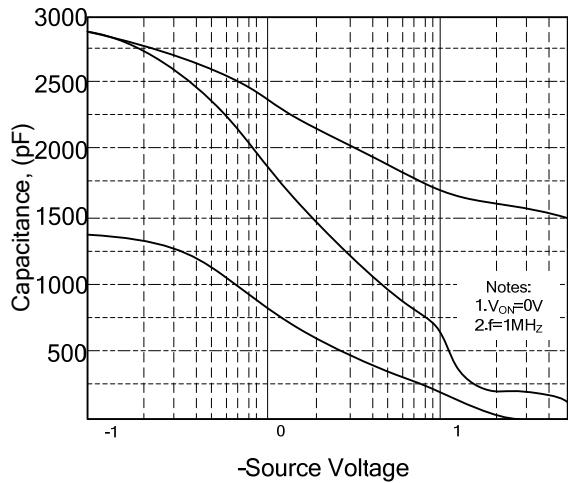
On-Resistance Variation vs. Drain Current and Gate Voltage



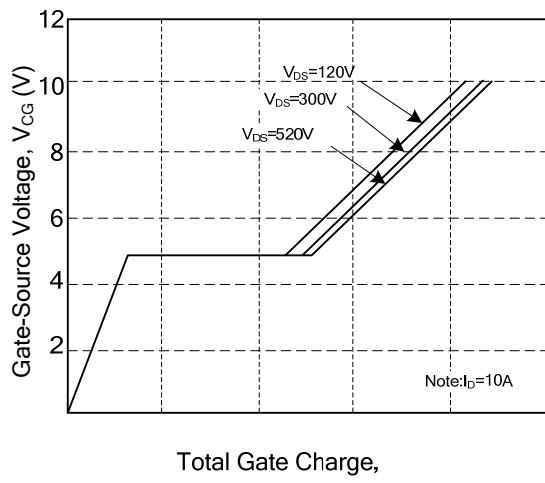
Body Diode Forward Voltage Variation with Source Current and Temperature



Capacitance Characteristics



Gate Charge Characteristics



RATING AND CHARACTERISTIC CURVES (10N65F)

